



LD39100XX

LD39100XX12, LD39100XX25

1 A, low quiescent current, low noise voltage regulator

Features

- Input voltage from 1.5 to 5.5 V
- Ultra low dropout voltage (200 mV typ. at 1 A load)
- Very low quiescent current (20 μ A typ. at no load, 200 μ A typ. at 1 A load, 1 μ A max in off mode)
- Very low noise with no bypass capacitor (30 μ V_{RMS} at V_{OUT} = 0.8 V)
- Output voltage tolerance: $\pm 2.0\%$ @ 25 °C
- 1 A guaranteed output current
- Wide range of output voltages available on request: 0.8 V to 4.5 V with 100 mV step and adjustable from 0.8 V
- Logic-controlled electronic shutdown
- Stabilized with ceramic capacitors C_{OUT} = 1 μ F
- Internal current and thermal limit
- DFN6 (3 x 3 mm) package
- Temperature range: - 40 °C to 125 °C

Applications

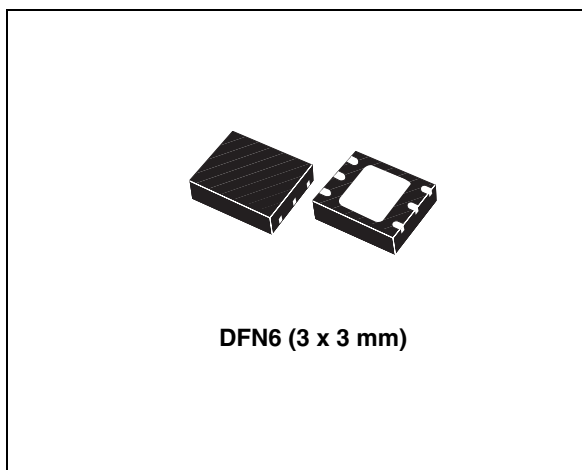
- Printers
- Personal digital assistants (PDAs)
- Cordless phones
- Consumer applications

Description

The LD39100xx provides 1 A maximum current from an input voltage ranging from 1.5 V to 5.5 V

Table 1. Device summary

Part numbers	Order codes	Output voltages
LD39100XX	LD39100PUR	Adj. from 0.8 V
LD39100XX12	LD39100PU12R	1.2 V
LD39100XX25	LD39100PU25R	2.5 V



with a typical dropout voltage of 200 mV. The device is stable due to the use of ceramic capacitors on the input and output. The ultra low drop-voltage, low quiescent current and low noise features make it suitable for low power battery powered applications. Power supply rejection is 65 dB at low frequencies and starts to roll off at 10 kHz. An enable logic control function puts the LD39100xx in shutdown mode, allowing a total current consumption lower than 1 μ A. The device also includes short-circuit constant current limiting and thermal protection.

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1 Circuit schematics

Figure 1. Schematic diagram for the LD39100PU

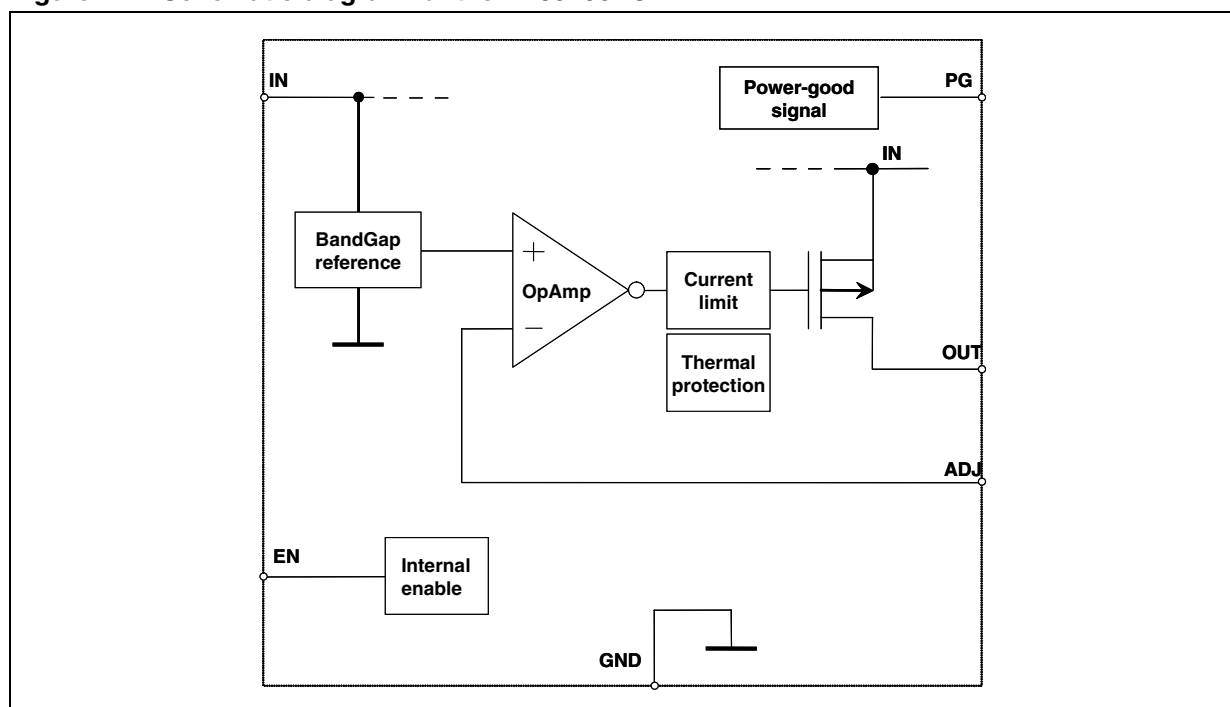
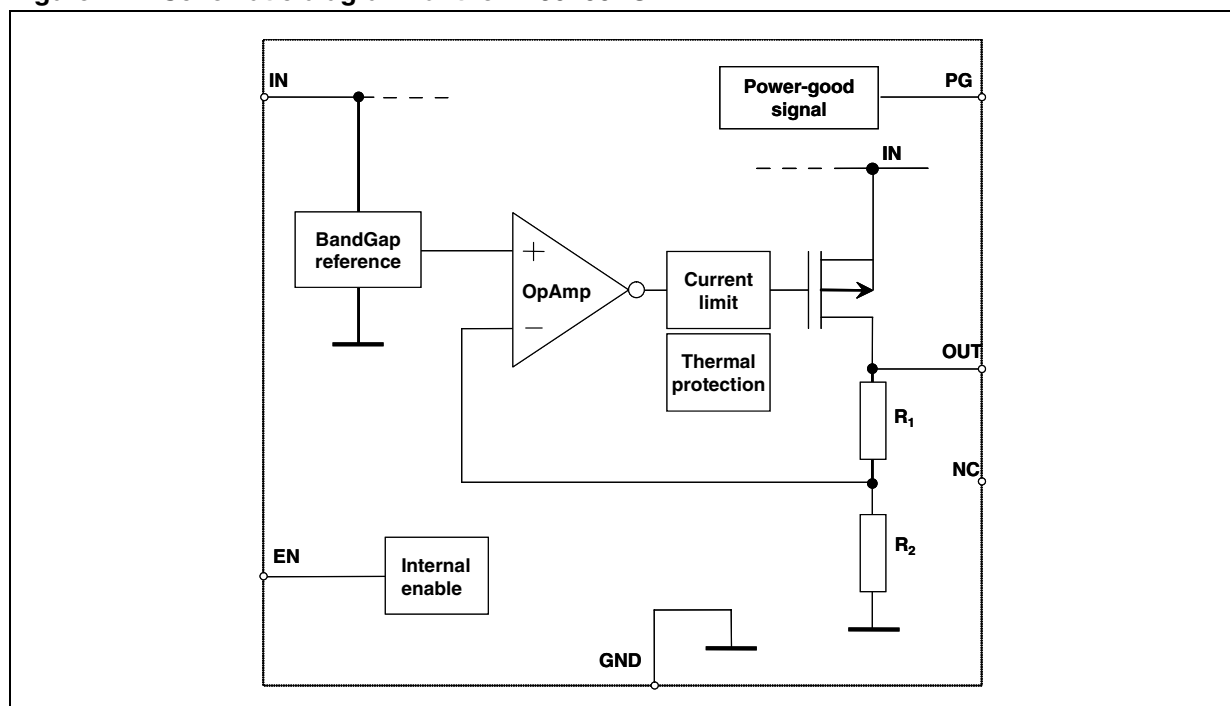


Figure 2. Schematic diagram for the LD39100PUxx



2 Pin configuration

Figure 3. Pin connection (top view)

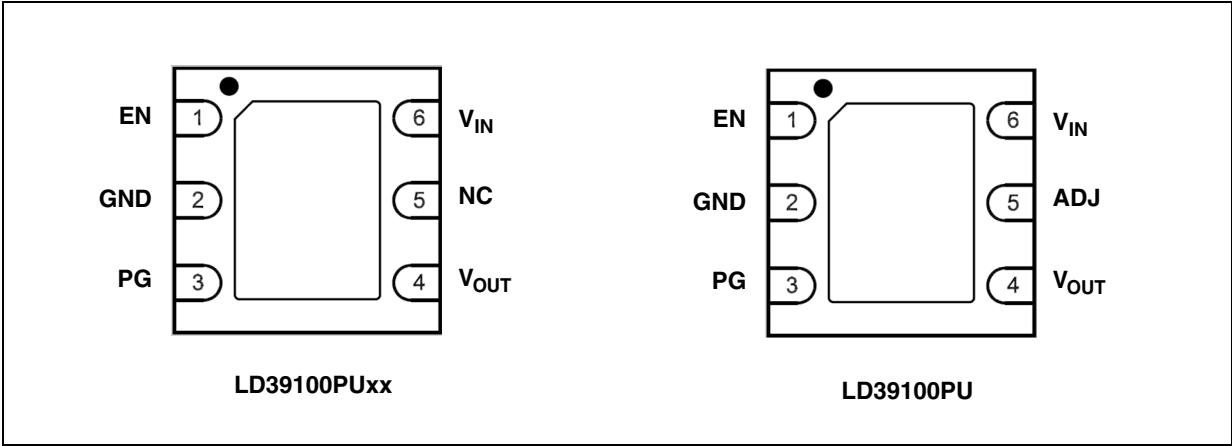


Table 2. Pin description

Symbol	Pin n°		Function
	LD39100PU	LD39100PUxx	
EN	1	1	Enable pin logic input: Low = shutdown, High = active
GND	2	2	Common ground
PG	3	3	Power Good
V _{OUT}	4	4	Output voltage
ADJ	5	-	Adjust pin
V _{IN}	6	6	Input voltage of the LDO
NC	-	5	Not connected
GND	EXP pad		Exposed pad must be connected to GND

3 Maximum ratings

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{IN}	DC input voltage	-0.3 to 7	V
V_{OUT}	DC output voltage	-0.3 to $V_{IN} + 0.3$ (7 V max)	V
EN	Enable pin	-0.3 to $V_{IN} + 0.3$ (7 V max)	V
PG	Power Good pin	-0.3 to 7	V
ADJ	Adjust pin	4	V
I_{OUT}	Output current	Internally limited	
P_D	Power dissipation	Internally limited	
T_{STG}	Storage temperature range	- 65 to 150	°C
T_{OP}	Operating junction temperature range	- 40 to 125	°C

Note: Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. All values are referred to GND.

Table 4. Thermal data

Symbol	Parameter	Value	Unit
R_{thJA}	Thermal resistance junction-ambient	55	°C/W
R_{thJC}	Thermal resistance junction-case	10	°C/W

Table 5. ESD performance

Symbol	Parameter	Test conditions	Value	Unit
ESD	ESD protection voltage	HBM	4	kV
		MM	0.4	kV

4 Electrical characteristics

$T_J = 25\text{ }^{\circ}\text{C}$, $V_{IN} = 1.8\text{ V}$, $C_{IN} = C_{OUT} = 1\text{ }\mu\text{F}$, $I_{OUT} = 100\text{ mA}$, $V_{EN} = V_{IN}$, unless otherwise specified.

Table 6. Electrical characteristics for the LD39100PU

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{IN}	Operating input voltage		1.5		5.5	V
V_{ADJ}	V_{ADJ} accuracy	$I_{OUT}=10\text{ mA}$, $T_J = 25^{\circ}\text{C}$	784	800	816	mV
		$I_{OUT}=10\text{ mA}$, $-40^{\circ}\text{C} < T_J < 125^{\circ}\text{C}$	776	800	824	
I_{ADJ}	Adjust pin current				1	μA
ΔV_{OUT}	Static line regulation	$V_{OUT}+1\text{ V} \leq V_{IN} \leq 5.5\text{ V}$, $I_{OUT}=100\text{ mA}$		0.01		%/V
ΔV_{OUT}	Transient line regulation ⁽¹⁾	$\Delta V_{IN}=500\text{ mV}$, $I_{OUT}=100\text{ mA}$, $t_R=5\mu\text{s}$		10		mVpp
		$\Delta V_{IN}=500\text{ mV}$, $I_{OUT}=100\text{ mA}$, $t_F=5\mu\text{s}$		10		
ΔV_{OUT}	Static load regulation	$I_{OUT}=10\text{ mA}$ to 1 A		0.002		%/mA
ΔV_{OUT}	Transient load regulation ⁽¹⁾	$I_{OUT}=10\text{ mA}$ to 1 A , $t_R=5\mu\text{s}$		40		mVpp
		$I_{OUT}=1\text{ A}$ to 10 mA , $t_F=5\mu\text{s}$		40		
V_{DROP}	Dropout voltage ⁽²⁾	$I_{OUT}=1\text{ A}$, V_O fixed to 1.5 V $-40^{\circ}\text{C} < T_J < 125^{\circ}\text{C}$		200	400	mV
e_N	Output noise voltage	10 Hz to 100 kHz , $I_{OUT}=100\text{ mA}$, $V_{OUT}=0.8\text{ V}$		30		μV_{RMS}
SVR	Supply voltage rejection $V_O = 0.8\text{ V}$	$V_{IN}=1.8\text{ V} \pm V_{RIPPLE}$ $V_{RIPPLE}=0.25\text{ V}$, freq. = 1 kHz $I_{OUT}=10\text{ mA}$		65		dB
		$V_{IN}=1.8\text{ V} \pm V_{RIPPLE}$ $V_{RIPPLE}=0.25\text{ V}$, freq.= 10 kHz $I_{OUT}=100\text{ mA}$		62		
I_Q	Quiescent current	$I_{OUT}=0\text{ mA}$		20		μA
		$I_{OUT}=0\text{ mA}$, $-40^{\circ}\text{C} < T_J < 125^{\circ}\text{C}$			50	
		$I_{OUT}=0$ to 1 A		200		
		$I_{OUT}=0$ to 1 A , $-40^{\circ}\text{C} < T_J < 125^{\circ}\text{C}$			300	
		V_{IN} input current in off mode: $V_{EN}=\text{GND}^{(3)}$		0.001	1	
PG	Power good output threshold	Rising edge		$0.92^* V_{OUT}$		V
		Falling edge		$0.8^* V_{OUT}$		
	Power good output voltage low	$I_{sink}=6\text{ mA}$ open drain output			0.4	V
I_{SC}	Short-circuit current	$R_L=0$		1.5		A

Table 6. Electrical characteristics for the LD39100PU (continued)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{EN}	Enable input logic low	$V_{IN}=1.5V$ to $5.5V$, $-40^{\circ}C < T_J < 125^{\circ}C$	0.9		0.4	V
	Enable input logic high					V
I_{EN}	Enable pin input current	$V_{EN} = V_{IN}$		0.1	100	nA
t_{ON}	Turn-on time ⁽⁴⁾			30		μs
T_{SHDN}	Thermal shutdown			160		$^{\circ}C$
	Hysteresis			20		
C_{OUT}	Output capacitor	Capacitance (see typical performance characteristics for stability)	1		22	μF

1. All transient values are guaranteed by design, not production tested
2. Dropout voltage is the input-to-output voltage difference at which the output voltage is 100 mV below its nominal value. This specification does not apply for output voltages below 1.5 V
3. PG pin floating
4. Turn-on time is time measured between the enable input just exceeding V_{EN} high value and the output voltage just reaching 95% of its nominal value

$T_J = 25\text{ }^{\circ}\text{C}$, $V_{IN} = V_{OUT(NOM)} + 1\text{ V}$, $C_{IN} = C_{OUT} = 1\text{ }\mu\text{F}$, $I_{OUT} = 100\text{ mA}$, $V_{EN} = V_{IN}$, unless otherwise specified.

Table 7. Electrical characteristics for LD39100PUxx

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_I	Operating input voltage		1.5		5.5	V
V_{OUT}	V_{OUT} accuracy	$V_{OUT} > 1.5\text{ V}$, $I_{OUT} = 10\text{ mA}$, $T_J = 25\text{ }^{\circ}\text{C}$	-2.0		2.0	%
		$V_{OUT} > 1.5\text{ V}$, $I_{OUT} = 10\text{ mA}$, $-40\text{ }^{\circ}\text{C} < T_J < 125\text{ }^{\circ}\text{C}$	-3.0		3.0	
		$V_{OUT} \leq 1.5\text{ V}$, $I_{OUT} = 10\text{ mA}$		± 20		mV
		$V_{OUT} \leq 1.5\text{ V}$, $I_{OUT} = 10\text{ mA}$, $-40\text{ }^{\circ}\text{C} < T_J < 125\text{ }^{\circ}\text{C}$		± 30		
ΔV_{OUT}	Static line regulation	$V_{OUT} + 1\text{ V} \leq V_{IN} \leq 5.5\text{ V}$, $I_{OUT} = 100\text{ mA}$		0.01		%/V
ΔV_{OUT}	Transient line regulation ⁽¹⁾	$\Delta V_{IN} = 500\text{ mV}$, $I_{OUT} = 100\text{ mA}$, $t_R = 5\text{ }\mu\text{s}$		10		mVpp
		$\Delta V_{IN} = 500\text{ mV}$, $I_{OUT} = 100\text{ mA}$, $t_F = 5\text{ }\mu\text{s}$		10		
ΔV_{OUT}	Static load regulation	$I_{OUT} = 10\text{ mA}$ to 1 A		0.002		%/mA
ΔV_{OUT}	Transient load regulation ⁽¹⁾	$I_{OUT} = 10\text{ mA}$ to 1 A , $t_R = 5\text{ }\mu\text{s}$		40		mVpp
		$I_{OUT} = 1\text{ A}$ to 10 mA , $t_F = 5\text{ }\mu\text{s}$		40		
V_{DROP}	Dropout voltage ⁽²⁾	$I_{OUT} = 1\text{ A}$, $V_{OUT} > 1.5\text{ V}$, $-40\text{ }^{\circ}\text{C} < T_J < 125\text{ }^{\circ}\text{C}$		200	400	mV
e_N	Output noise voltage	10Hz to 100kHz, $I_{OUT} = 100\text{ mA}$, $V_{OUT} = 2.5\text{ V}$		85		μV_{RMS}
SVR	Supply voltage rejection $V_{OUT} = 1.5\text{ V}$	$V_{IN} = V_{OUT(NOM)} + 0.5\text{ V} \pm V_{RIPPLE}$ $V_{RIPPLE} = 0.1\text{ V}$, freq. = 1kHz $I_{OUT} = 10\text{ mA}$		65		dB
		$V_{IN} = V_{OUT(NOM)} + 0.5\text{ V} \pm V_{RIPPLE}$ $V_{RIPPLE} = 0.1\text{ V}$, freq. = 10 kHz $I_{OUT} = 100\text{ mA}$		62		
I_Q	Quiescent current	$I_{OUT} = 0\text{ mA}$		20		μA
		$I_{OUT} = 0\text{ mA}$, $-40\text{ }^{\circ}\text{C} < T_J < 125\text{ }^{\circ}\text{C}$			50	
		$I_{OUT} = 0$ to 1 A		200		
		$I_{OUT} = 0$ to 1 A , $-40\text{ }^{\circ}\text{C} < T_J < 125\text{ }^{\circ}\text{C}$			300	
		V_{IN} input current in OFF mode: $V_{EN} = \text{GND}^{(3)}$		0.001	1	
PG	Power good output threshold	Rising edge		$0.92^* V_{OUT}$		V
		Falling edge		$0.8^* V_{OUT}$		
	Power good output voltage low	$I_{sink} = 6\text{ mA}$ open drain output			0.4	V
I_{SC}	Short-circuit current	$R_L = 0$		1.5		A
V_{EN}	Enable input logic low	$V_{IN} = 1.5\text{ V}$ to 5.5 V , $-40\text{ }^{\circ}\text{C} < T_J < 125\text{ }^{\circ}\text{C}$			0.4	V
	Enable input logic high		0.9			V

Table 7. Electrical characteristics for LD39100PUxx (continued)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{EN}	Enable pin input current	$V_{EN} = V_{IN}$		0.1	100	nA
T_{ON}	Turn-on time ⁽⁴⁾			30		μs
T_{SHDN}	Thermal shutdown			160		°C
	Hysteresis			20		
C_{OUT}	Output capacitor	Capacitance (see typical performance characteristics for stability)	1		22	μF

1. All transient values are guaranteed by design, not production tested
2. Dropout voltage is the input-to-output voltage difference at which the output voltage is 100 mV below its nominal value. This specification does not apply for output voltages below 1.5 V
3. PG pin floating
4. Turn-on time is time measured between the enable input just exceeding V_{EN} high Value and the output voltage just reaching 95% of its nominal value

5 Typical performance characteristics

$C_{IN} = C_{OUT} = 1 \mu F.$

Figure 4. V_{ADJ} accuracy

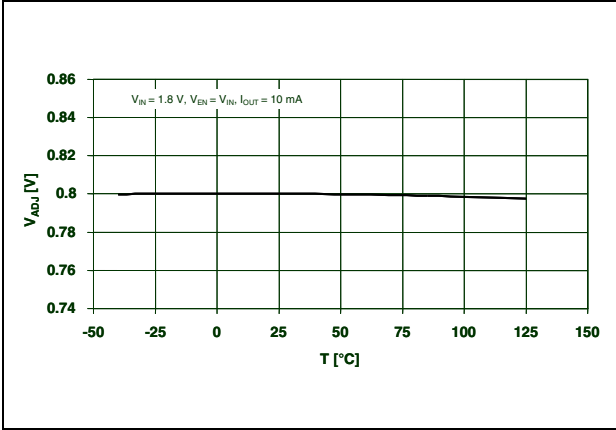


Figure 5. V_{OUT} accuracy

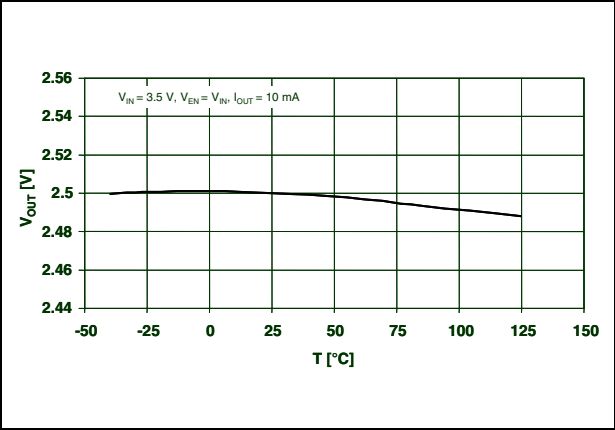


Figure 6. Dropout voltage vs. temperature ($V_{OUT} = 2.5 V$)

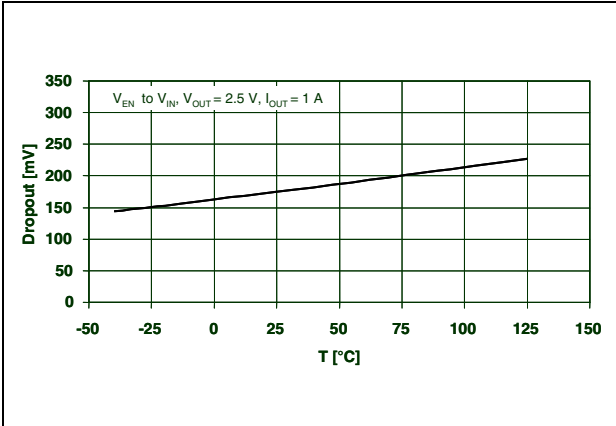


Figure 7. Dropout voltage vs. temperature ($V_{OUT} = 1.5 V$)

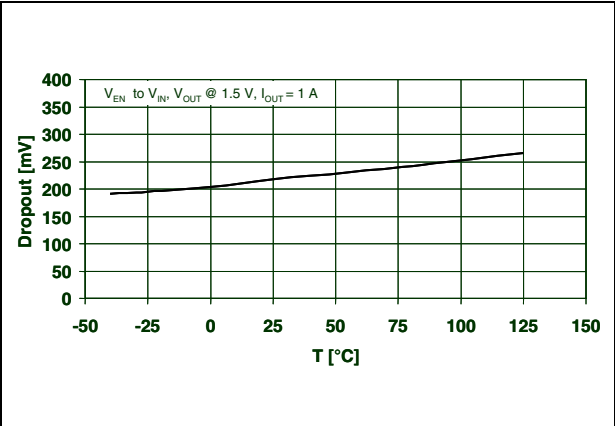


Figure 8. Dropout voltage vs. output current

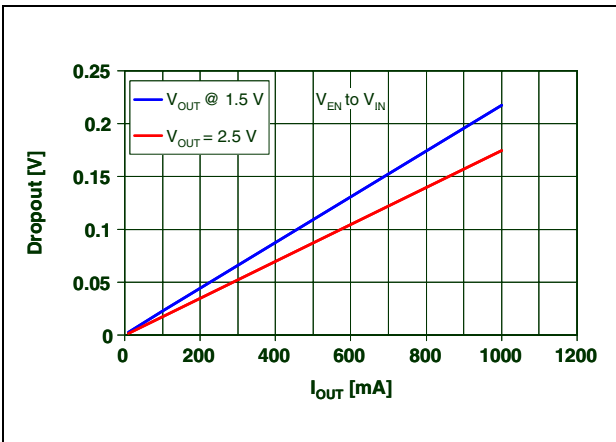


Figure 9. Short-circuit current vs. drop voltage

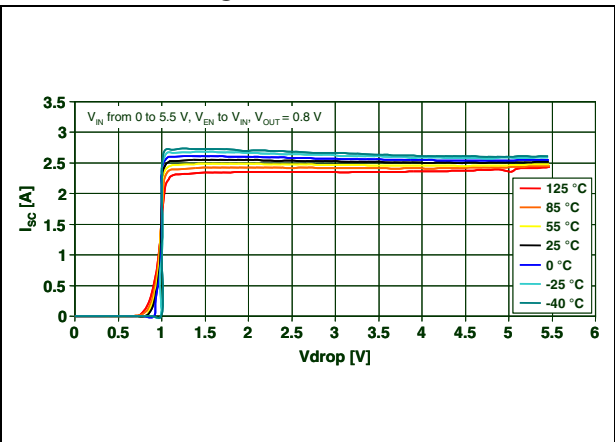


Figure 10. Output voltage vs. input voltage
($V_{OUT} = 0.8 \text{ V}$)

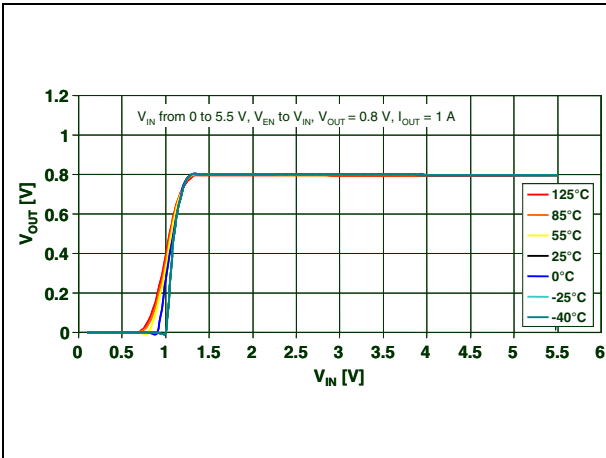


Figure 11. Output voltage vs. input voltage
($V_{OUT} = 2.5 \text{ V}$)

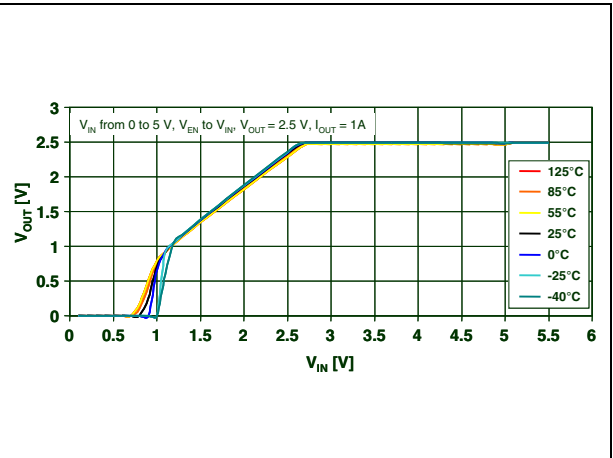


Figure 12. Quiescent current vs. temperature

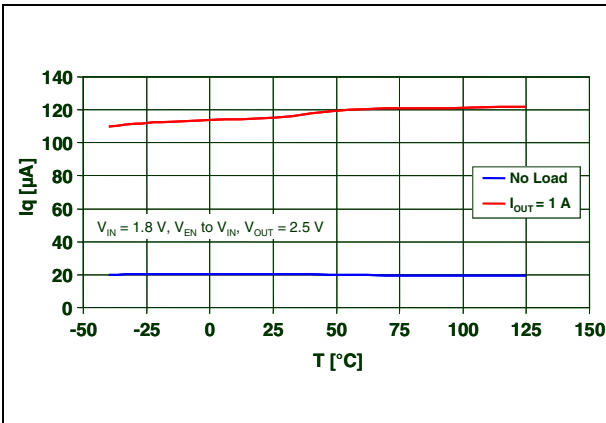


Figure 13. V_{IN} input current in off mode vs. temperature

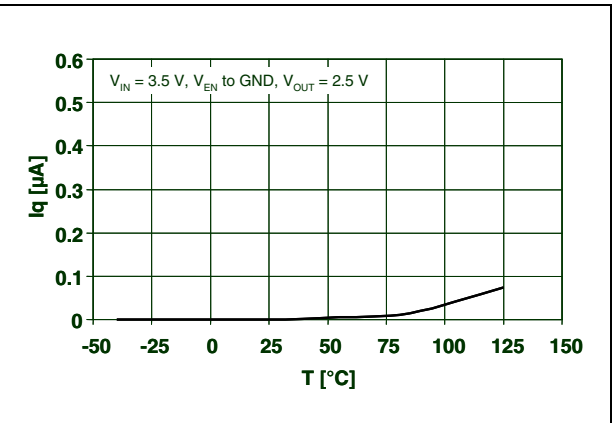


Figure 14. Load regulation

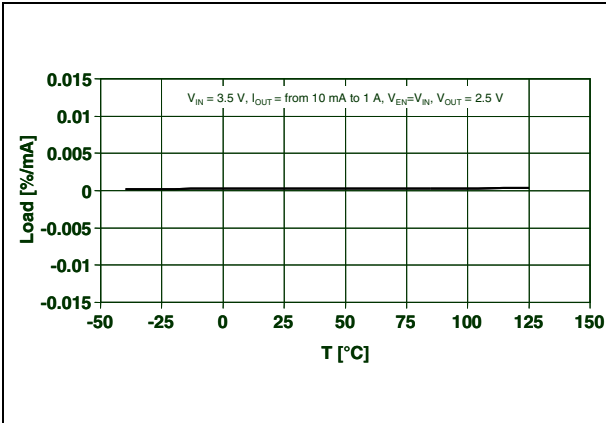


Figure 15. Line regulation

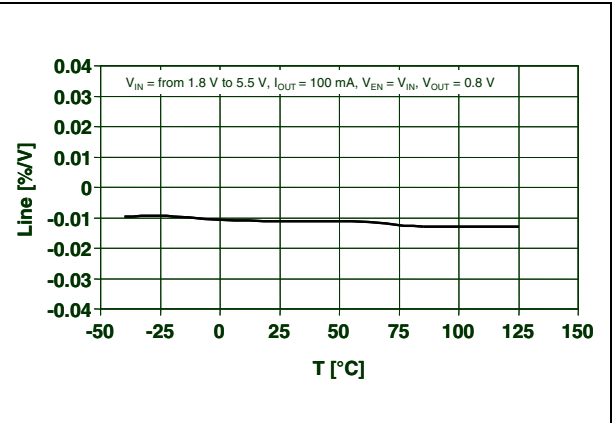


Figure 16. Line regulation

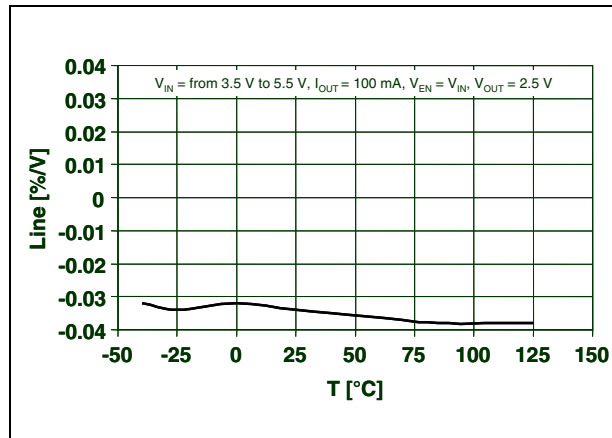
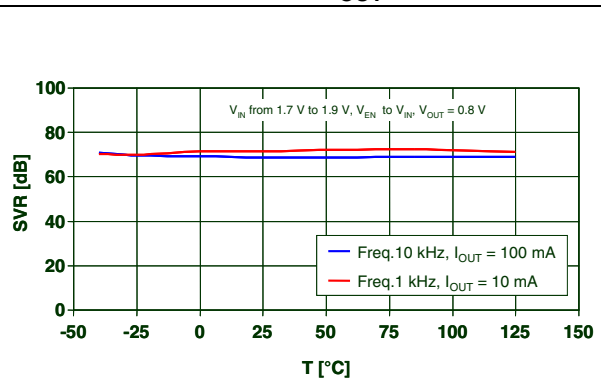
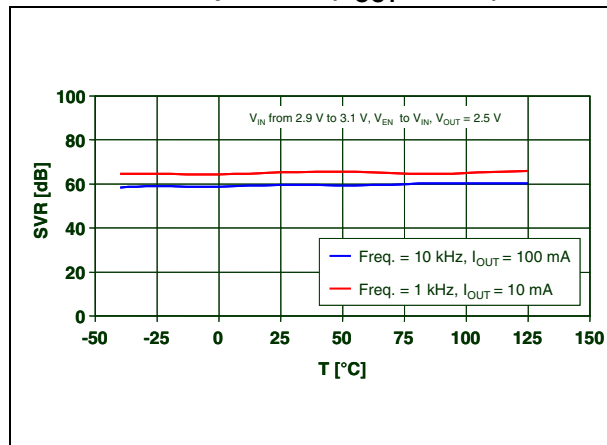
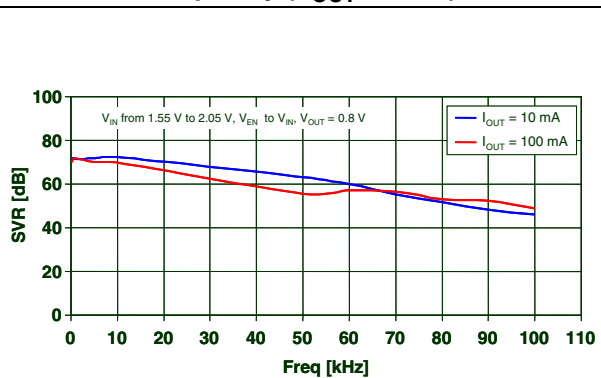
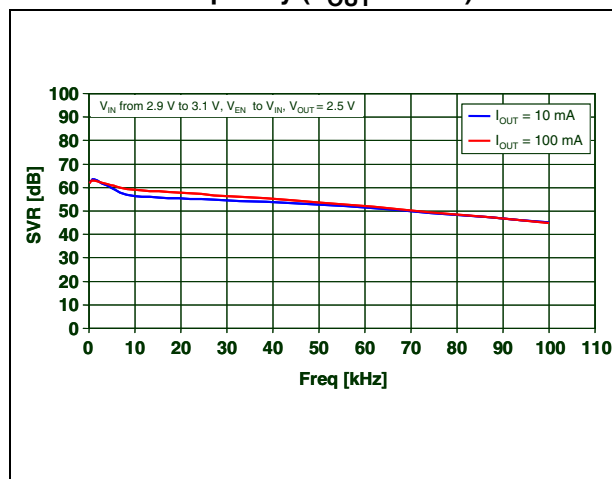
Figure 17. Supply voltage rejection vs. temperature ($V_{OUT} = 0.8$ V)Figure 18. Supply voltage rejection vs. temperature ($V_{OUT} = 2.5$ V)Figure 19. Supply voltage rejection vs. frequency ($V_{OUT} = 0.8$ V)Figure 20. Supply voltage rejection vs. frequency ($V_{OUT} = 2.5$ V)

Figure 21. Output noise voltage vs. frequency

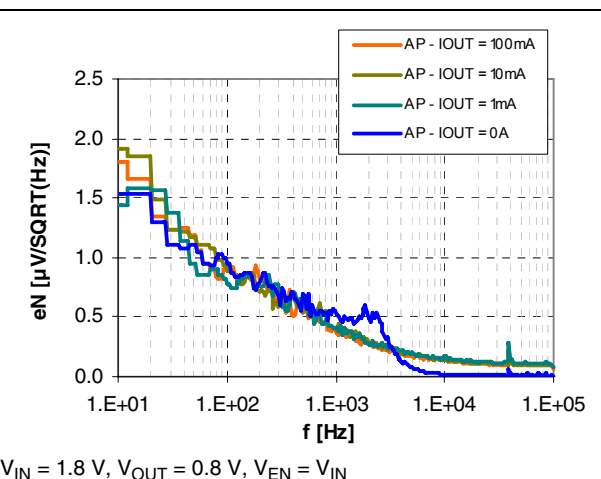


Figure 22. Enable voltage vs. temperature

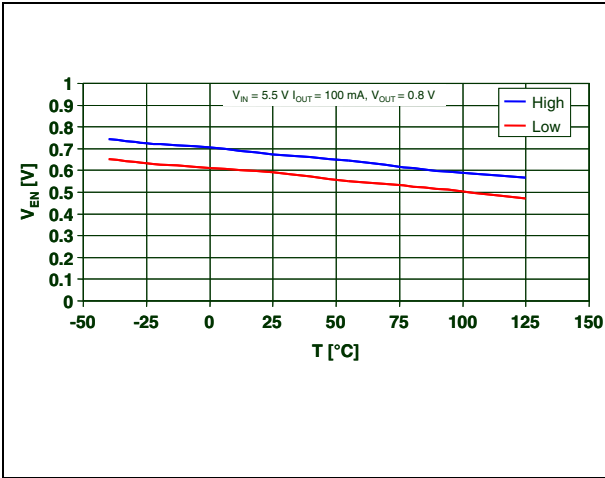


Figure 23. Load transient (I_{OUT} = from 10 mA to 1 A)

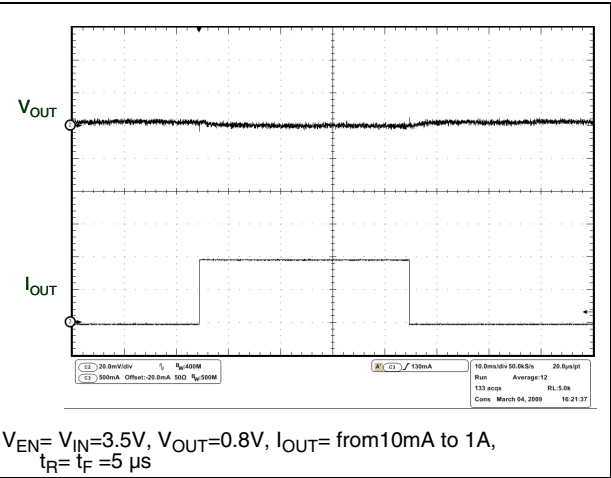


Figure 24. Load transient ($V_{OUT} = 0.8\text{ V}$)

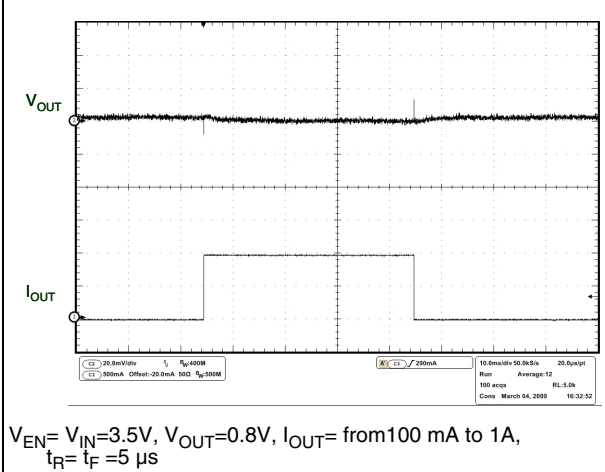


Figure 25. Load transient ($V_{OUT} = 2.5\text{ V}$)

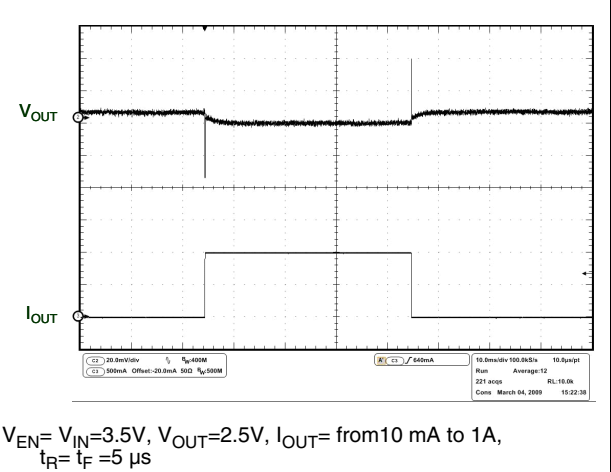


Figure 26. Load transient (I_{OUT} = from 100 mA to 1 A)

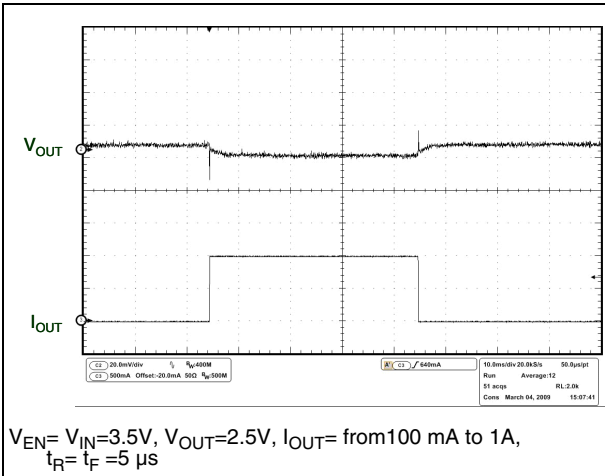


Figure 27. Line regulation transient

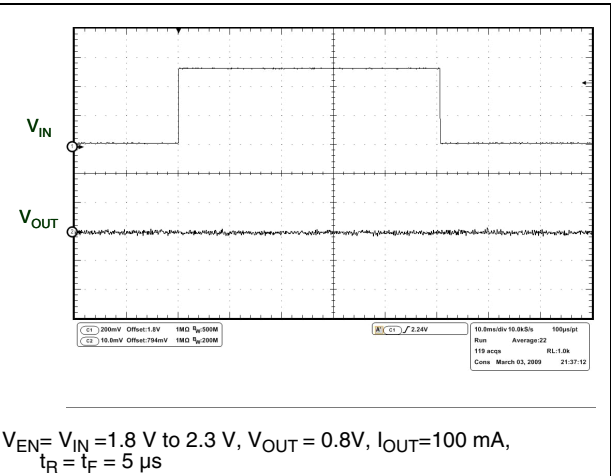


Figure 28. Startup transient

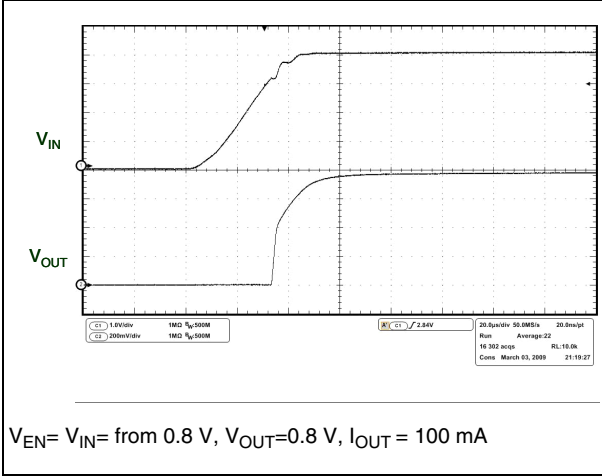


Figure 29. Enable transient

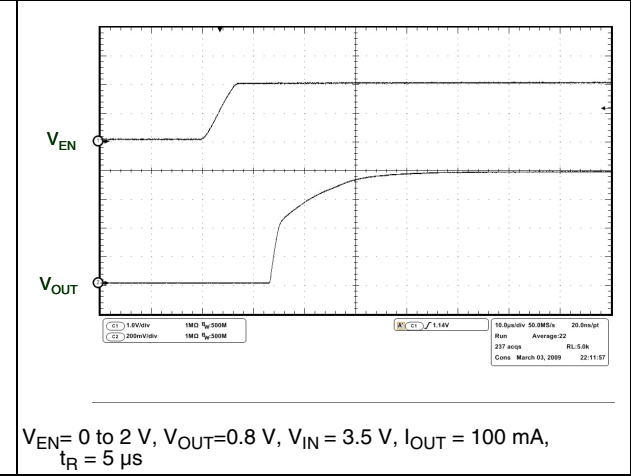


Figure 30. ESR required for stability with ceramic capacitors ($V_{OUT} = 0.8 \text{ V}$)

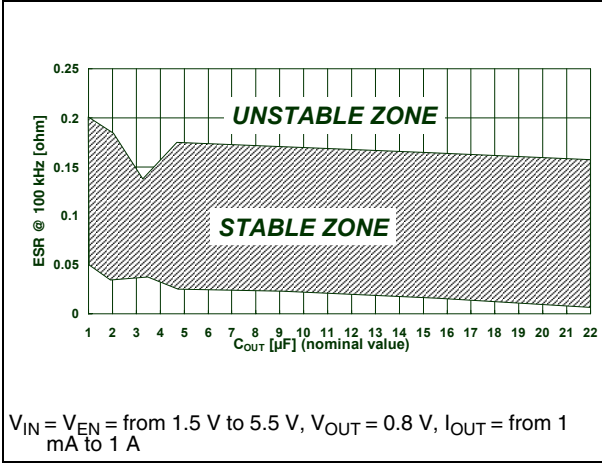
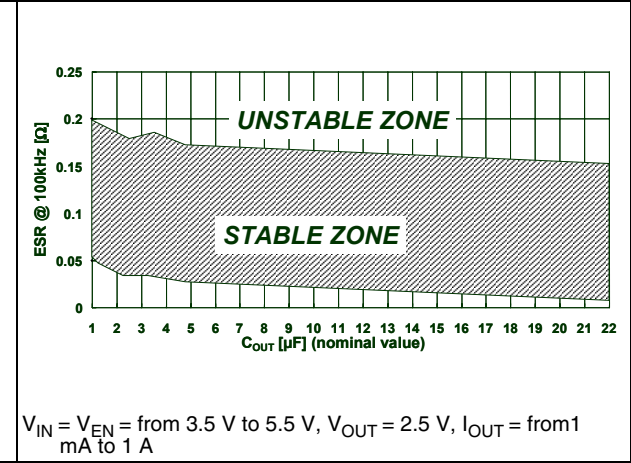


Figure 31. ESR required for stability with ceramic capacitors ($V_{OUT} = 2.5 \text{ V}$)



6 Application information

The LD39100xx is an ultra low dropout linear regulator. It provides up to 1 A with a low 200 mV dropout. The input voltage range is from 1.5 V to 5.5 V. The device is available in fixed and adjustable output versions.

The regulator is equipped with internal protection circuitry, such as short-circuit current limiting and thermal protection.

The regulator is stable due to ceramic capacitors on the input and the output. The expected values of the input and output ceramic capacitors are from 1 μ F to 22 μ F with 1 μ F typical. The input capacitor must be connected within 0.5 inches of the V_{IN} terminal. The output capacitor must also be connected within 0.5 inches of output pin. There is no upper limit to the value of the input capacitor.

[Figure 32](#) and [Figure 33](#) illustrate the typical application schematics:

Figure 32. Typical application circuit for the fixed output version

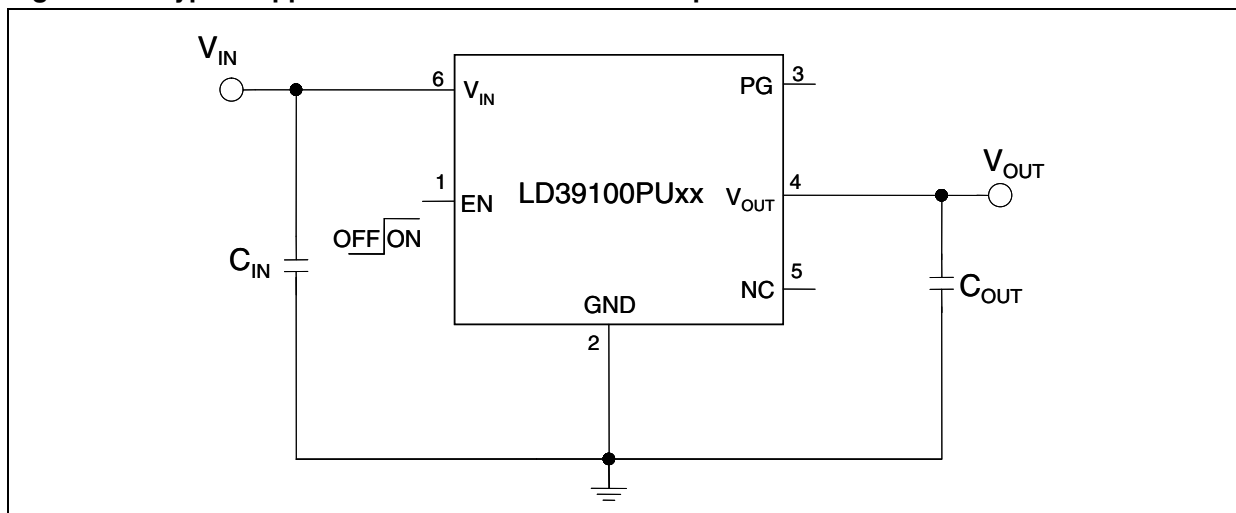
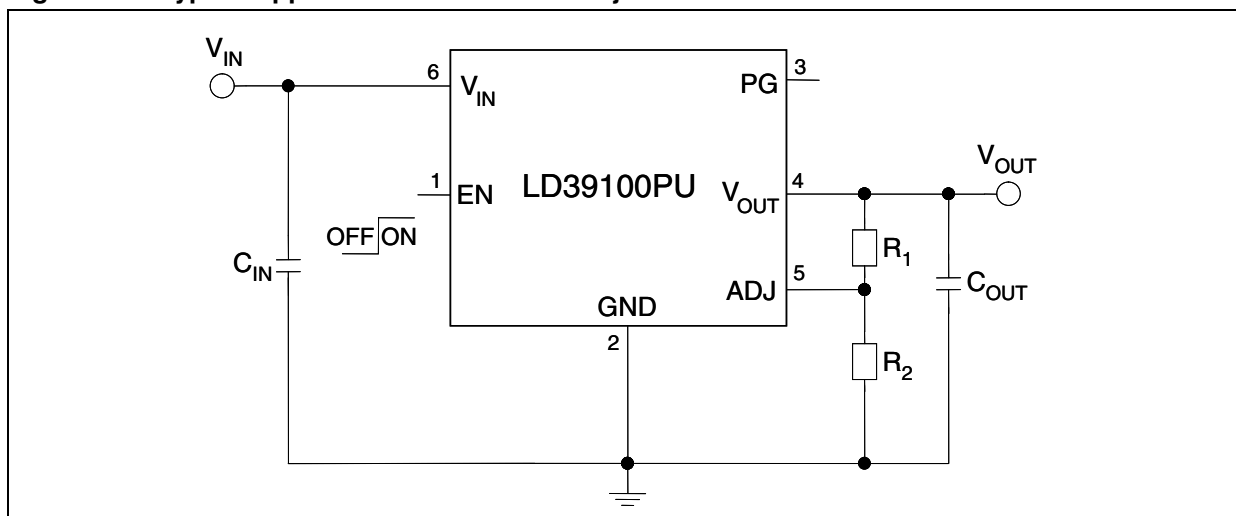


Figure 33. Typical application circuit for the adjustable version



For the adjustable version, the output voltage can be adjusted from 0.8 V up to the input voltage, minus the voltage drop across the PMOS (dropout voltage), by connecting a resistor divider between the ADJ pin and the output, thus allowing remote voltage sensing.

The resistor divider should be selected using the following equation:

$$V_{OUT} = V_{ADJ} (1 + R_1 / R_2) \text{ with } V_{ADJ} = 0.8 \text{ V (typ.)}$$

It is recommended to use resistors with values in the range of 10 kΩ to 50 kΩ. Lower values can also be suitable, but will increase current consumption.

6.1 Power dissipation

An internal thermal feedback loop disables the output voltage if the die temperature rises to approximately 160 °C. This feature protects the device from excessive temperature and allows the user to push the limits of the power handling capability of a given circuit board without the risk of damaging the device.

It is very important to use a good PC board layout to maximize power dissipation. The thermal path for the heat generated by the device is from the die to the copper lead frame through the package leads and exposed pad to the PC board copper. The PC board copper acts as a heat sink. The footprint copper pads should be as wide as possible to spread and dissipate the heat to the surrounding ambient. Feed-through vias to the inner or backside copper layers are also useful in improving the overall thermal performance of the device.

The power dissipation of the device depends on the input voltage, output voltage and output current, and is given by:

$$P_D = (V_{IN} - V_{OUT}) I_{OUT}$$

The junction temperature of the device is:

$$T_{J_MAX} = T_A + R_{thJA} \times P_D$$

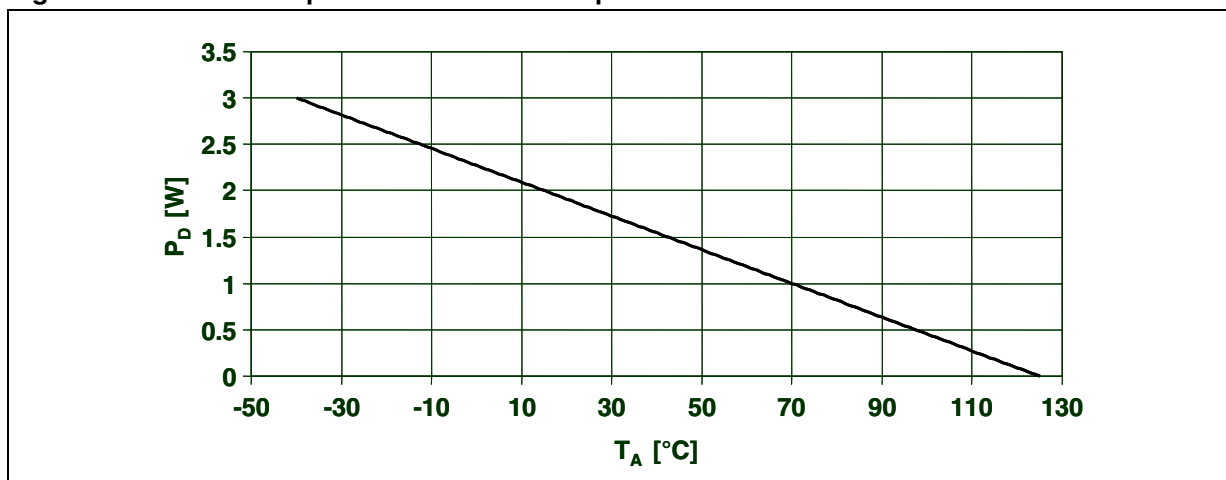
where:

T_{J_MAX} is the maximum junction of the die, 125 °C;

T_A is the ambient temperature;

R_{thJA} is the thermal resistance junction-to-ambient.

Figure 34. Power dissipation vs. ambient temperature



6.2 Enable function

The LD39100xx features an enable function. When the EN voltage is higher than 2 V, the device is ON, and if it is lower than 0.8 V, the device is OFF. In shutdown mode, consumption is lower than 1 μ A.

The EN pin does not have an internal pull-up, which means that it cannot be left floating if it is not used.

6.3 Power Good function

Most applications require a flag showing that the output voltage is in the correct range.

The Power Good threshold depends on the adjust voltage. When the adjust is higher than $0.92 \cdot V_{ADJ}$, the Power Good (PG) pin goes to high impedance. If the adjust is below $0.80 \cdot V_{ADJ}$, the PG pin goes to low impedance. If the device is functioning well, the Power Good pin is at high impedance. If the output voltage is fixed using an external or internal resistor divider, the Power Good threshold is $0.92 \cdot V_{OUT}$.

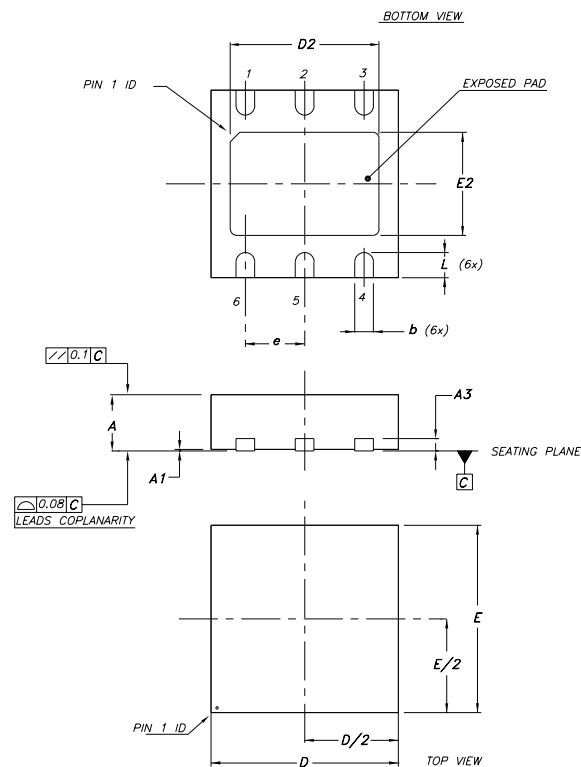
The use of the Power Good function requires an external pull-up resistor, which must be connected between the PG pin and V_{IN} or V_{OUT} . The typical current capability of the PG pin is up to 6 mA. The use of a pull-up resistor for PG in the range of 100 k Ω to 1 M Ω is recommended. If the Power Good function is not used, the PG pin must remain floating.

7 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

DFN6 (3x3 mm) mechanical data

Dim.	mm.			inch.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.80	0.90	1.00	0.031	0.035	0.039
A1	0	0.02	0.05	0	0.001	0.002
A3		0.20			0.008	
b	0.23	0.30	0.38	0.009	0.012	0.015
D	2.90	3.00	3.10	0.114	0.118	0.122
D2	2.23	2.38	2.48	0.088	0.094	0.098
E	2.90	3.00	3.10	0.114	0.118	0.122
E2	1.50	1.65	1.75	0.059	0.065	0.069
e		0.95			0.037	
L	0.30	0.40	0.50	0.012	0.016	0.020



7946637A

Tape & reel QFNxx/DFNxx (3x3) mechanical data

Dim.	mm.			inch.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			18.4			0.724
Ao		3.3			0.130	
Bo		3.3			0.130	
Ko		1.1			0.043	
Po		4			0.157	
P		8			0.315	

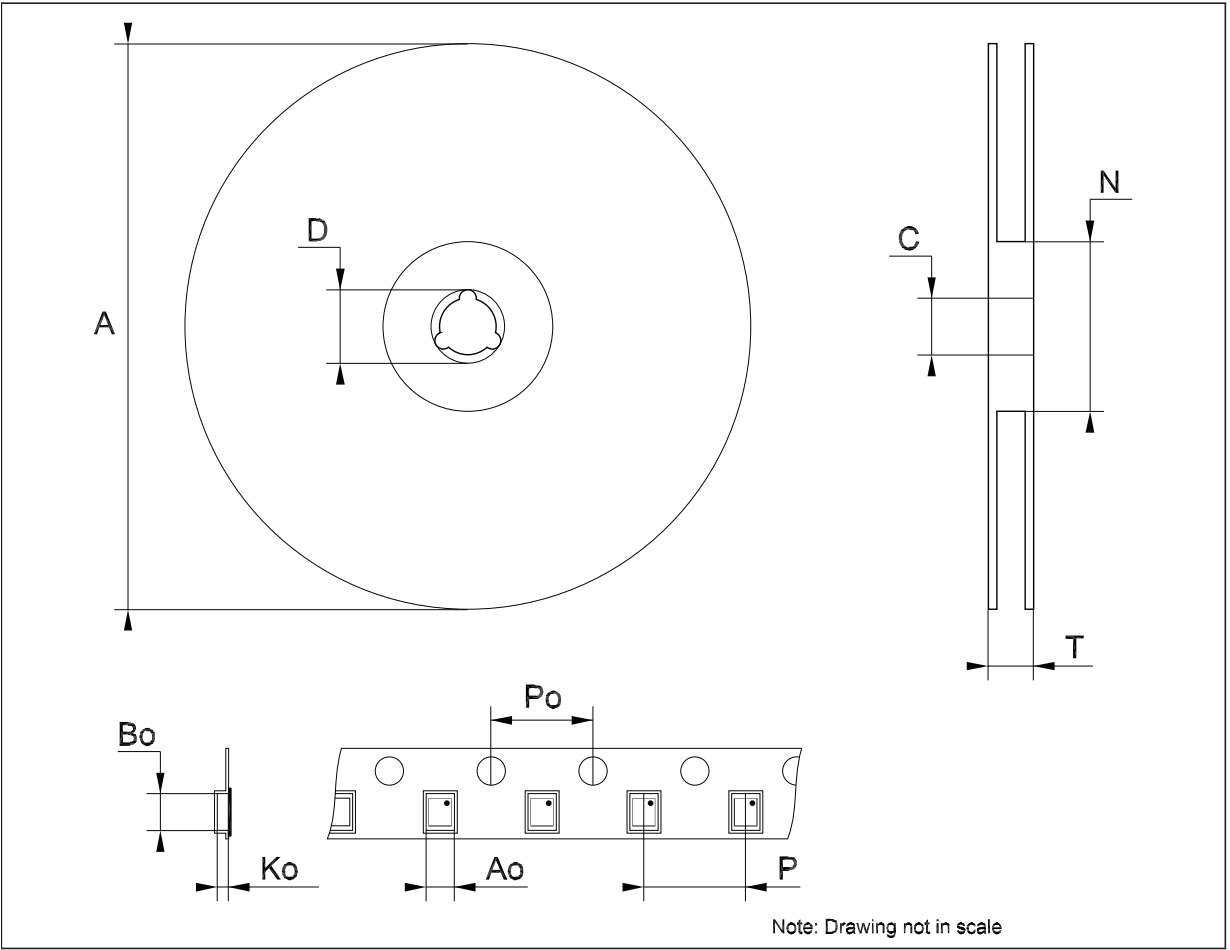
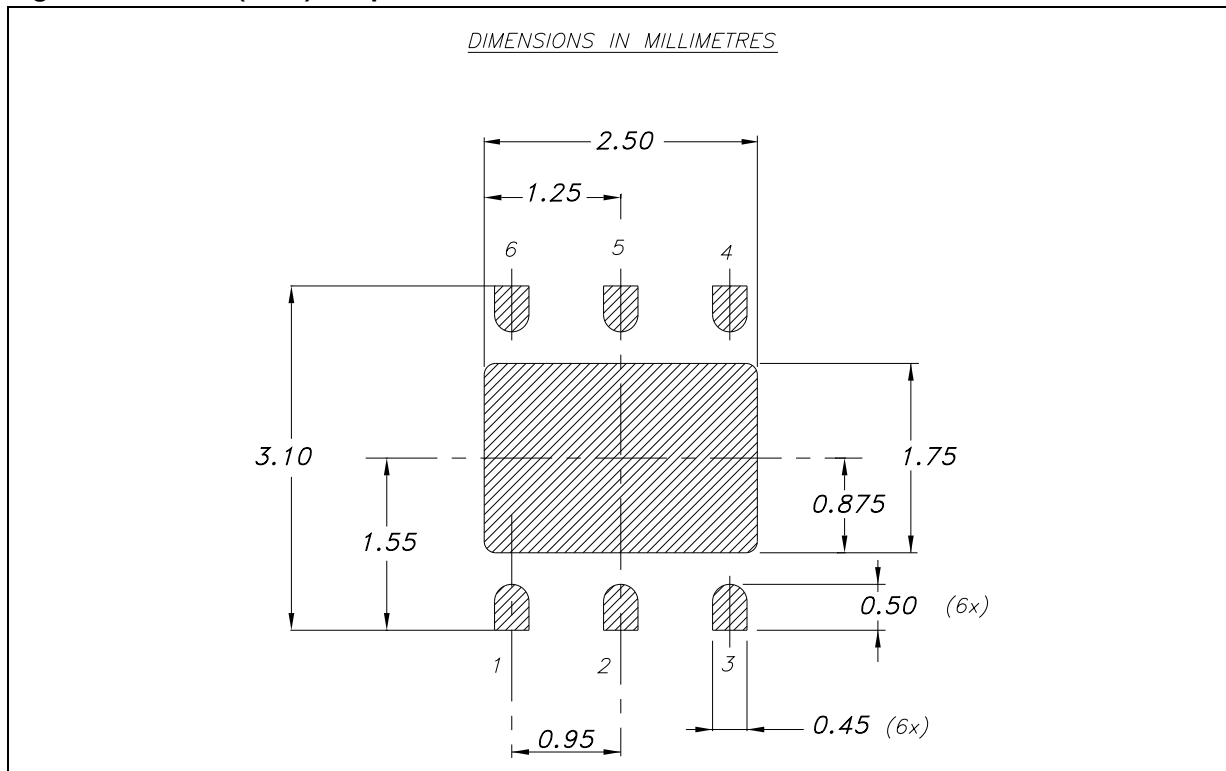


Figure 35. DFN6 (3 x 3) footprint recommended data



8 Revision history

Table 8. Document revision history

Date	Revision	Changes
29-Jul-2009	1	Initial release.
16-Apr-2010	2	Modified <i>Figure 8 on page 10</i> .
11-Oct-2011	3	Document status promoted from preliminary data to datasheet.

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